

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YI XIE	12/20/2017
YUE YU	12/20/2017
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15886955
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NAME OF SUBMITTER:	MARY DONNA BERKLEY
SIGNATURE:	/Mary Donna Berkley/
DATE SIGNED:	02/02/2018
Total Attachments: 3	
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ASSIGNMENT

In exchange for good and valuable consideration, the receipt of which is hereby acknowledged, we, **YI XIE and YUE YU**, hereby sell, assign and transfer to Integrated Device Technology, Inc., a Delaware corporation, (hereinafter referred to as "ASSIGNEE"), having a place of business at 6024 Silver Creek Valley Road, San Jose, CA 95138, the full and exclusive right title and interest in and to any and all improvements disclosed in the application for United States Patent entitled "**HIGH SIGNAL VOLTAGE TOLERANCE IN SINGLE-ENDED MEMORY INTERFACE**", filed on _____ and having Serial No. _____, any and all divisions, reissues, continuations, substitutions, reexaminations, renewals and foreign equivalents thereof, all rights of priority resulting from the filing of said application, and any and all Letters Patents which issue from said application, together with all claims for damages by reason of past infringement of said patent and with the right to sue for and collect the same;

We hereby authorize and request the Officials of the United States Patent and Trademark Office and of any and all foreign Patent Offices to issue and all of said Letters Patents, when granted, to said ASSIGNEE as the assignee of our entire right, title and interest in and to the same, for the sole use of said ASSIGNEE, its successors and assigns, to the full end of the term for which said Letters Patents may be granted;

On request, We agree to execute all oaths, declarations, assignments, powers of attorney and other papers related to said application and any and all divisions, reissues, continuations, substitutions, reexaminations, renewals and foreign equivalents thereof; communicate to said ASSIGNEE, its successors, assigns and representatives all facts known to me concerning said improvements and the history thereof; and generally do everything possible to assist and aid said ASSIGNEE in obtaining, securing and maintaining patent protection for said improvements and for vesting title to said improvements and any and all applications for and patents on said improvements in said ASSIGNEE, its successors and assigns;

We have made no previous assignment, grant, mortgage, license or other agreement to or with others affecting the rights and property conveyed herein; and

We hereby grant to the firm of CHRISTOPHER P. MAIORANA, P.C. located at 24840 Harper Avenue, Suite 100, St. Clair Shores, Michigan 48080, the power to insert on this document any further identification necessary or desirable to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Yi XIE
Signature of First Joint Inventor

Date: Dec. 20th, 2017

Yi Xie
Name of First Joint Inventor

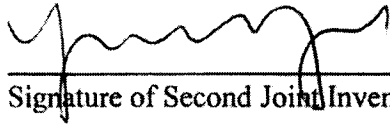
Date: _____

Signature of Second Joint Inventor

Yue Yu
Name of Second Joint Inventor

Signature of First Joint Inventor

Yi Xie
Name of First Joint Inventor



Signature of Second Joint Inventor

Yue Yu
Name of Second Joint Inventor

Date: _____

Date: 12/20/2017